

•General Description

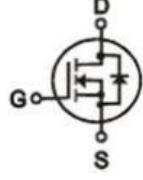
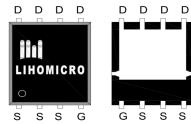
The SGT MOSFET LHL40N100 has the low $R_{DS(on)}$, low gate charge, fast switching and excellent avalanche characteristics. This device is suitable for fast charge and lighting.

•Features

- Fast switching
- Low $R_{DS(on)}$ & FOM

•Application

- LED/LCD/PDP TV and monitor Lighting
- Power Supplies

	V_{DS} =100V $R_{DS(ON)} = 13m\Omega$ I_D = 40A
■ RoHS COMPLIANT 	DFN5*6

•Ordering Information:

Part Number	LHL40N100		
Package	DFN5*6		
Basic Ordering Unit (pcs)	5000		
Normal Package Material Ordering Code	LHL40N100N-DFN5*6-TAP		
Halogen Free Ordering Code	LHL40N100N-DFN5*6-TAP-HF		

•Absolute Maximum Ratings (TC =25°C)

PARAMETER	SYMBOL	Value	UNIT
Drain-Source Breakdown Voltage	BV _{DSS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current ,T _C = 25°C	I _D	40	A
Pulsed drain current (T _C = 25°C, tp limited by Tjmax) ¹	I _D pulse	120	A
Single Pulse Avalanche Energy ⁴	E _{AS}	30	mJ
Power Dissipation(T _C =25°C) ²	P _D	72	W
Operating Temperature	T _J	-55~+150	°C
Storage Temperature	T _{STG}	-55~+150	°C

•Electronic Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	V_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	100	--	--	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	1.0	--	2.5	V
Drain-source On Resistance ³	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 20A$	--	10	13	$m\Omega$
		$V_{GS} = 4.5V, I_D = 15A$	--	15	19	
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 100V, V_{GS} = 0V, T_J = 25^\circ C$	--	--	1	μA
		$V_{DS} = 80V, V_{GS} = 0V, T_J = 85^\circ C$	--	--	10	
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 20V, V_{DS} = 0V$	--	--	± 100	nA
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 50V, f = 1.0MHz$	--	1191	--	pF
Output Capacitance	C_{oss}		--	195	--	
Reverse transfer Capacitance	C_{rss}		--	4.1	--	
Turn-On Delay time	$T_{d(on)}$	$V_{GS} = 10V, V_{DS} = 50V, R_G = 2.2\Omega, I_D = 10A$	--	17.8	--	nS
Turn -Off Delay Time	$T_{d(off)}$		--	33.5	--	
Turn-On Rise time	T_r		--	3.9	--	
Turn-Off Fall time	T_f		--	3.2	--	
Total Gate Charge	Q_g	$I_D = 10A, V_{DS} = 50V, V_{GS} = 10V$	--	20	--	nC
Gate-to-Source Charge	Q_{gs}		--	2.4	--	
Gate-to-Drain Charge	Q_{gd}		--	5.3	--	
Continuous Diode Forward Current	I_s	--	--	--	40	A
Pulsed Diode Forward Current	I_{SM}	--	--	--	120	A
Diode Forward Voltage	V_{SD}	$T_J = 25^\circ C, I_s = 8A, V_{GS} = 0V$	--	--	1.3	V
Reverse Recovery Time	T_{rr}	$I_s = 8A, dI/dt = 100A/\mu s$	--	51	--	nS
Reverse Recovery Charge	Q_{rr}		--	95	--	nC
Peak Reverse Recovery Current	I_{rrm}		--	2.5	--	A

•Thermal Characteristics

PARAMETER	SYMBOL	MAX	UNIT
Thermal Resistance Junction-case	R_{thJC}	1.72	$^\circ C/W$
Thermal Resistance Junction-ambient ³	R_{thJA}	62	$^\circ C/W$

Notes:

1.Repetitive Rating: Pulse width limited by maximum junction temperature.

2.Pd is based on max. junction temperature,using junction-case thermal resistance.

3.The value of R_{thA} is measured with the device mounted on 1 in 2 FR-4 board with 2oz copper,in a Still air environment with $T_a = 25^\circ C$.

4. $V_{DD} = 50V, R_G = 25\Omega$, Starting $T_J = 25^\circ C$.

•Typical Characteristics

Figure 1. Typ. output characteristics

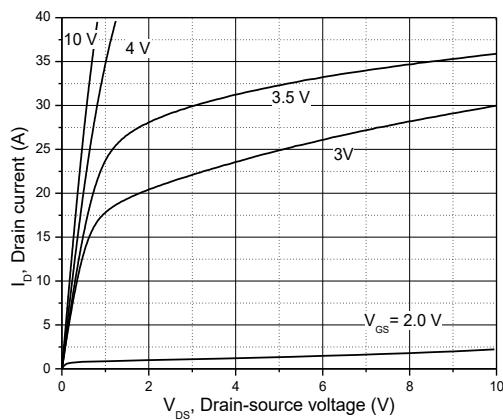


Figure 2. Typ. transfer characteristics

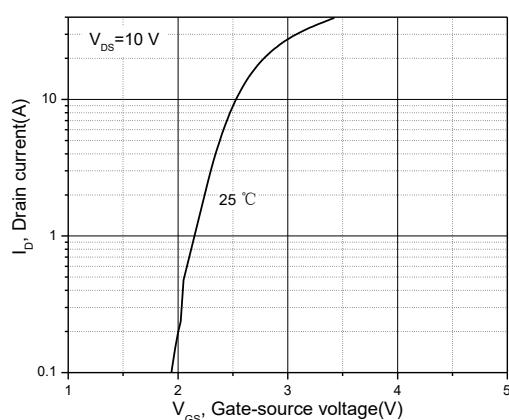


Figure 3. Typ. capacitances

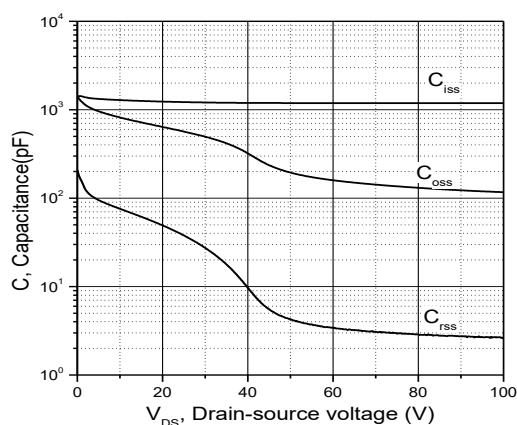


Figure 4.Typ. gate charge

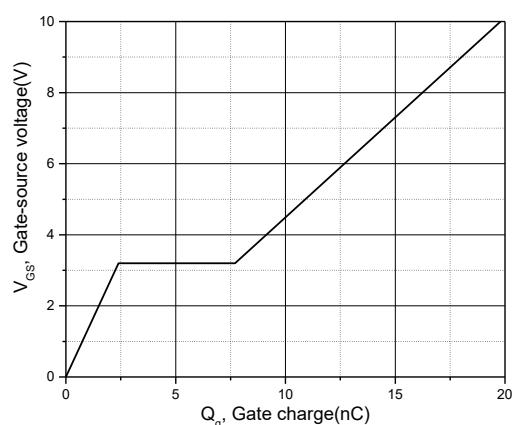


Figure 5. Drain-source breakdown voltage

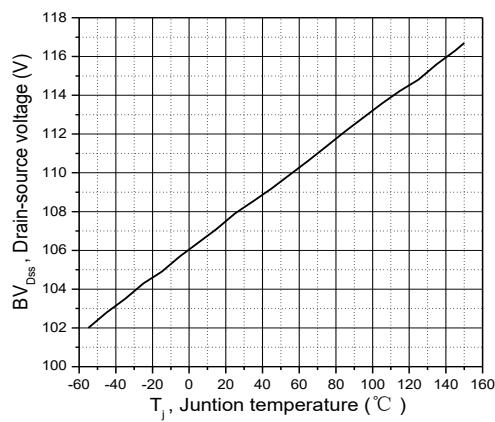
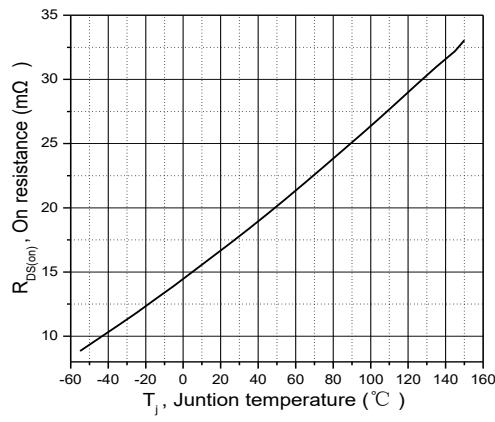


Figure 6. Drain-source on-state resistance



- **Typical Characteristics (cont.)**

Figure 7. Forward characteristic of body diode

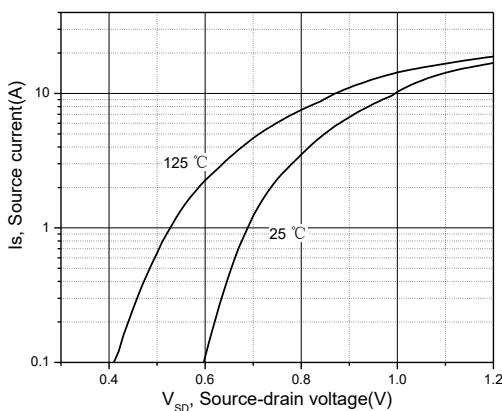


Figure 8. Drain-source on-state resistance

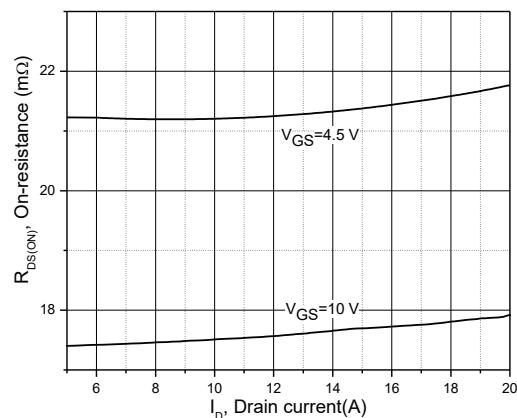
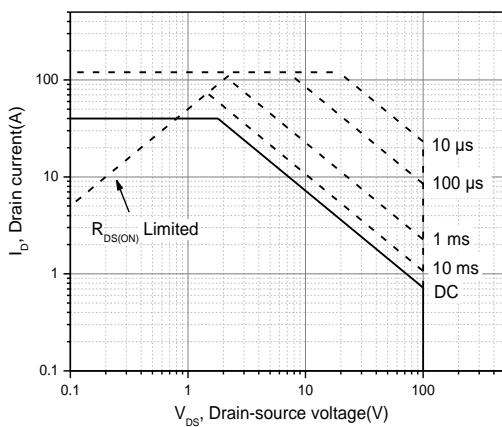


Figure 9. Safe operation area TC=25 °C



• Test Circuits & Waveforms

Figure 1. Gate charge test circuit & waveform

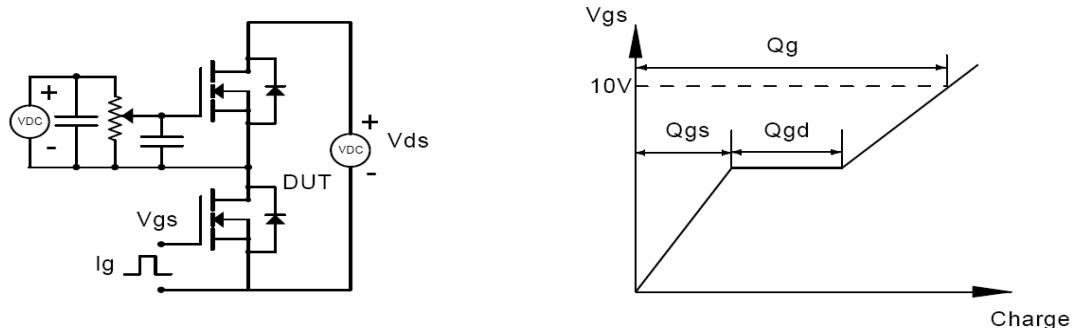


Figure 2. Switching time test circuit & waveforms

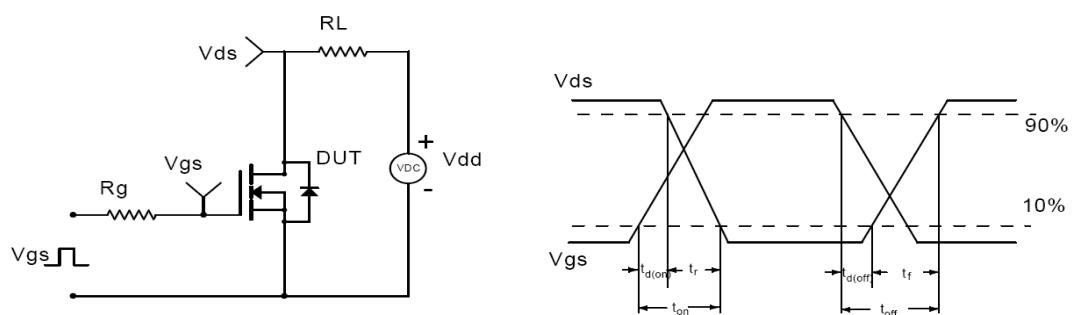


Figure 3. Unclamped inductive switching (UIS) test circuit & waveforms

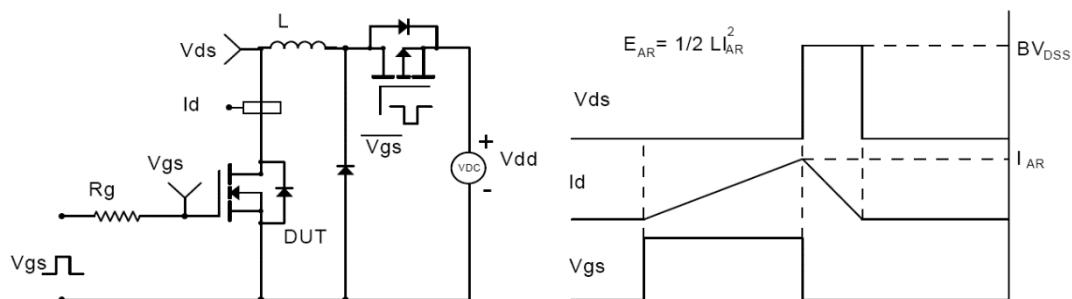
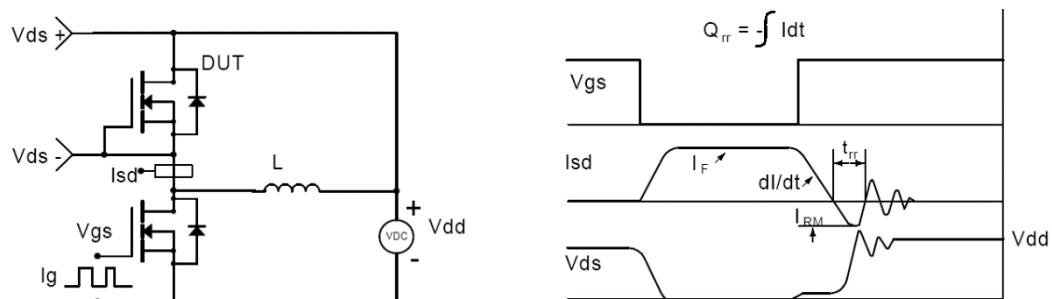


Figure 4. Diode reverse recovery test circuit & waveforms



•Dimensions (DFN5*6)

Unit: mm

SYMBOL	min	max	SYMBOL	min	max
A	1.00	1.20	e	1.27BSC	
b	0.30	0.50	L	0.05	0.30
c	0.20	0.30	L1	0.40	0.80
D	4.80	5.20	L2	1.20	2.00
D1	3.90	4.30	H	3.30	3.80
E	5.50	5.90	I	-	0.18
E1	5.90	6.40			

